### Amendment to the Specification

## At Paragraph [0004]:

U.S. patent application Ser. No. <u>10/652,270</u> (Attorney Docket-No. <u>15064US02</u>), entitled "Method and System Data Placement of Out-Of-Order Frames" filed on Aug. 29, 2003.

## At Paragraph [0034]:

Some embodiments of the TEEC 70 are described in, for example, U.S. patent application Ser. <u>60/456,265</u> (Attorney Docket No. <u>13782US02</u>), entitled "System and Method for TCP Offload" filed on Aug. 29, 2003. The above-referenced U.S. patent application is hereby incorporated herein by reference in its entirety.

### At Paragraph [0035]:

Some embodiments of the TOE 70 are described in, for example, U.S. Provisional Patent Application Serial No. 60/408,207, entitled "System and Method for Fault Tolerant TCP Offload" and filed on Sep. 4, 2002; U.S. patent application Ser. No. 10/337,029, entitled "System and Method for Fault Tolerant TCP Offload" and filed on Jan. 6, 2003; U.S. Provisional Patent Application Serial No. 60/411,294, entitled "System and Method for Handling Partially Processed Frames" and filed on Sep. 17, 2002; U.S. patent application Ser. No. 10/302,474, entitled "System and Method for Handling Frames in Multiple Stack Environment" and filed on Nov. 21, 2002; U.S. Provisional Patent Application Serial No. 60/410.022, entitled "System and Method for TCP Offloading and Uploading" and filed on Sep. 11, 2002; U.S. patent application Ser. No. 10/298,817, entitled "System and Method for TCP Offloading and Uploading" and filed on Nov. 18. 2002; U.S. Provisional Patent Application Serial No. 60/408,617, entitled "System and Method for TCP/IP Offload" and filed on Sep. 6, 2002; and U.S. patent application Ser. No. 60/456,265 (Attorney Docket No. 13782US02), entitled "System and Method for TCP/IP Offload" and filed on Aug. 29, 2003. The abovereferenced U.S. patent applications are all hereby incorporated herein by reference in their entirety.

# At Paragraph [0057]:

Exemplary receive and transmit paths a TEEC in accordance with an embodiment of the invention are described in U.S. patent application Ser. No. 60/456,265 (Attorney Docket No. 13782US02) filed Aug. 29, 2003 and is incorporated herein by reference in its entirety.